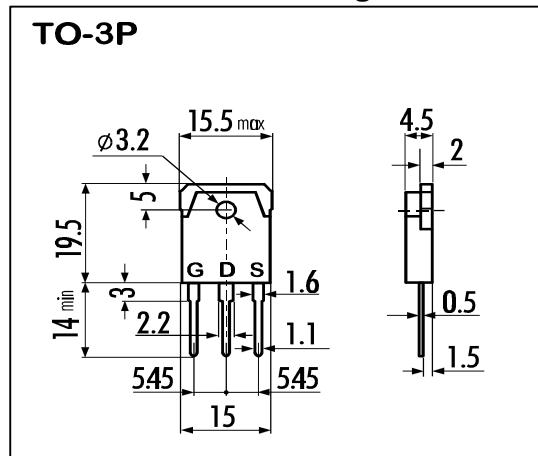


> Features

- High Speed Switching
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- $V_{GS} = \pm 30V$ Guarantee
- Repetitive Avalanche Rated

> Applications

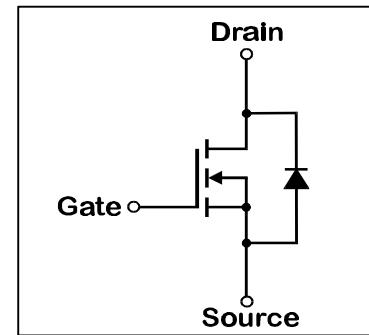
- Switching Regulators
- UPS
- DC-DC converters
- General Purpose Power Amplifier

> Outline Drawing

> Maximum Ratings and Characteristics

- Absolute Maximum Ratings ($T_C=25^\circ\text{C}$), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V_{DS}	450	V
Continuous Drain Current	I_D	± 8	A
Pulsed Drain Current	$I_{D(\text{puls})}$	± 32	A
Gate-Source-Voltage	V_{GS}	± 35	V
Repetitive or Non-Repetitive ($T_{ch} \leq 150^\circ\text{C}$)	I_{AR}	8	A
Avalanche Energy	E_{AS}	177.8	mJ
Max. Power Dissipation	P_D	60	W
Operating and Storage Temperature Range	T_{ch}	150	$^\circ\text{C}$
	T_{stg}	-55 ~ +150	$^\circ\text{C}$

$L=5.09\text{mH}, V_{CC}=45\text{V}$

> Equivalent Circuit


- Electrical Characteristics ($T_C=25^\circ\text{C}$), unless otherwise specified

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	BV_{DSS}	$I_D=1\text{mA}$ $V_{GS}=0\text{V}$	450			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$I_D=1\text{mA}$ $V_{DS}=V_{GS}$	3,5	4,0	4,5	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=450\text{V}$ $T_{ch}=25^\circ\text{C}$ $V_{GS}=0\text{V}$ $T_{ch}=125^\circ\text{C}$		10	500	μA
Gate Source Leakage Current	I_{GSS}	$V_{GS}=\pm 35\text{V}$ $V_{DS}=0\text{V}$		10	100	nA
Drain Source On-State Resistance	$R_{DS(on)}$	$I_D=4\text{A}$ $V_{GS}=10\text{V}$		1,0	1,2	Ω
Forward Transconductance	g_{fs}	$I_D=4\text{A}$ $V_{DS}=25\text{V}$	2	4		S
Input Capacitance	C_{iss}	$V_{DS}=25\text{V}$		540	810	pF
Output Capacitance	C_{oss}	$V_{GS}=0\text{V}$		100	150	pF
Reverse Transfer Capacitance	C_{rss}	$f=1\text{MHz}$		45	70	pF
Turn-On-Time t_{on} ($t_{on}=t_{d(on)}+t_f$)	$t_{d(on)}$	$V_{CC}=300\text{V}$		13	20	ns
	t_r	$I_D=8\text{A}$		40	60	ns
Turn-Off-Time t_{off} ($t_{off}=t_{d(off)}+t_f$)	$t_{d(off)}$	$V_{GS}=10\text{V}$		45	70	ns
	t_f	$R_{GS}=10\Omega$		25	40	ns
Avalanche Capability	I_{AV}	$L=5,09\text{mH}$ $T_{ch}=25^\circ\text{C}$	8			A
Diode Forward On-Voltage	V_{SD}	$I_F=2 \times I_{DR}$ $V_{GS}=0\text{V}$ $T_{ch}=25^\circ\text{C}$		1,1	1,65	V
Reverse Recovery Time	t_{rr}	$I_F=I_{DR}$ $V_{GS}=0\text{V}$		450		ns
Reverse Recovery Charge	Q_{rr}	$-dI_F/dt=100\text{A}/\mu\text{s}$ $T_{ch}=25^\circ\text{C}$		3,7		μC

> Thermal Characteristics

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance	$R_{th(ch-c)}$	channel to case			2,08	$^\circ\text{C/W}$
	$R_{th(ch-a)}$	channel to air			35,0	$^\circ\text{C/W}$

N-channel MOS-FET

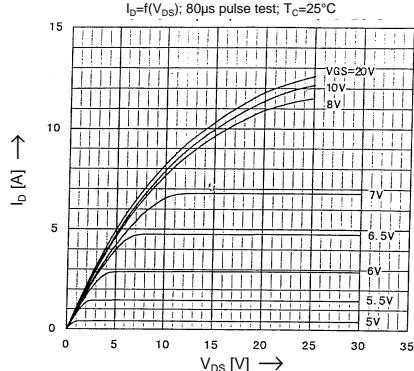
450V 1,2Ω ±8A 60W

2SK2873-01
FAP-II Series

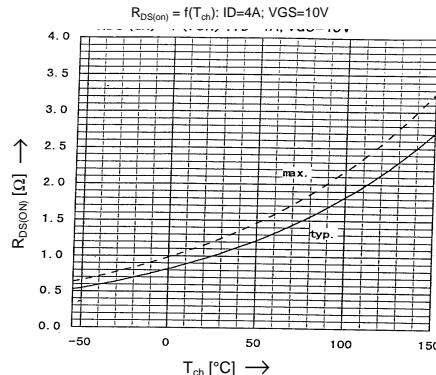
FUJI
ELECTRIC

> Characteristics

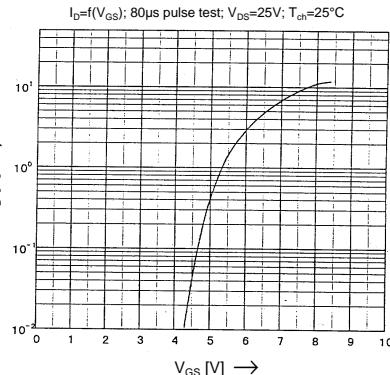
Typical Output Characteristics



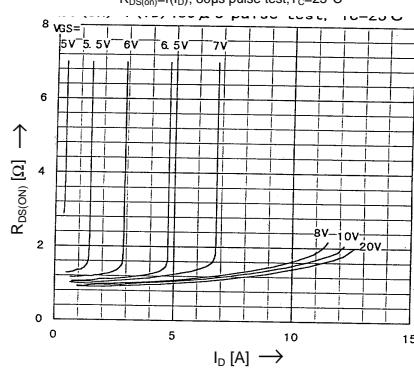
Drain-Source-On-State Resistance vs. T_{ch}



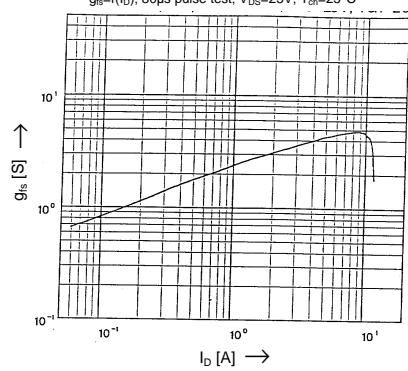
Typical Transfer Characteristics



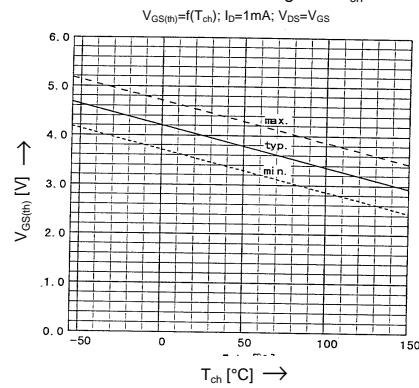
Typical Drain-Source-On-State-Resistance vs. I_D



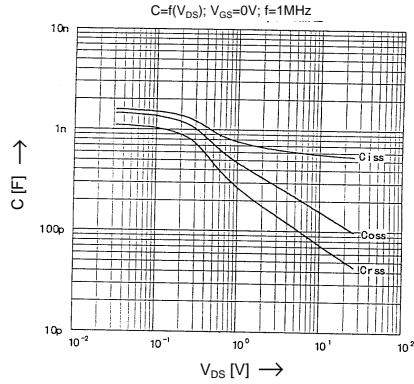
Typical Forward Transconductance vs. I_D



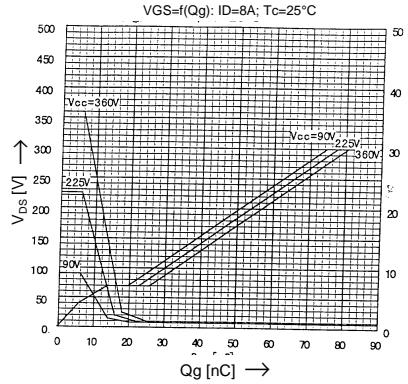
Gate Threshold Voltage vs. T_{ch}



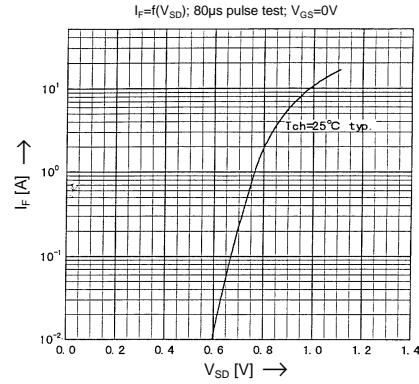
Typical Capacitances vs. V_{DS}



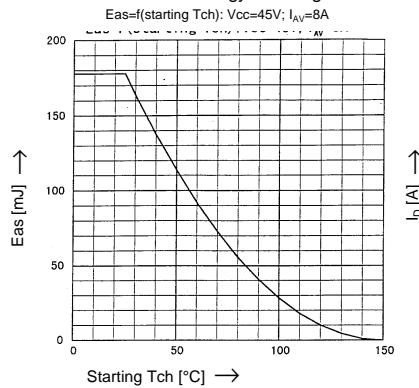
Typical Gate Charge Characteristic



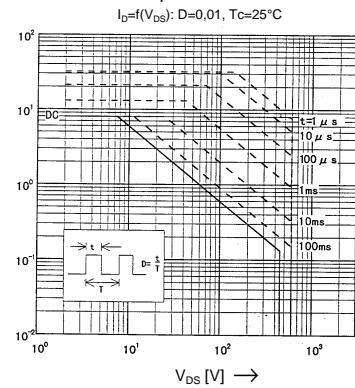
Forward Characteristics of Reverse Diode



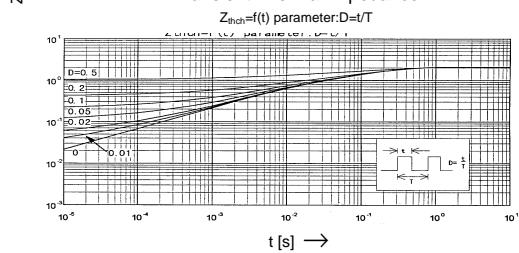
Avalanche Energy Derating



Safe operation area



Transient Thermal impedance



N-channel MOS-FET
450V 1,2Ω ±8A 60W

2SK2873-01
FAP-II Series

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ELECTRIC

> Characteristics

